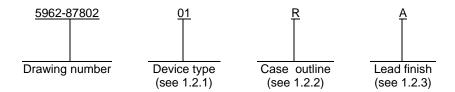
	REVISIONS																
LTR			DESCF	RIPTIO	N					DA	TE (YI	R-MO-I	DA)	APPROVED		)	
А	Add case 2 for ver Standardized Milit for dynamic and a	ary Drawing	CAGE c	ode 67:	268. A	dd test	55. Chaing at te	ange to	o ature	90-01-30		M. A. Frye					
В	Changes in accord	dance with N	OR 5962	2-R006	-94.					93-10-15		M. A. Frye					
С	Drawing updated	to reflect curr	ent requ	iremen	ts. Edi	torial c	hanges	throug	ghout.		01-0	)2-21		Raymond Monnin			
D	Redraw. Update paragraphs to new boilerplate requireme					rement	ts drw	/		11-11-07 Charles F. S			F. Sa	ffle			
REV SHEET REV SHEET REV SHEET REV STATUS OF SHEETS	AL FIRST SHEET CAGE CODE 67:	268  REV SHEET		G HAS	BEE	N REF	PLACE D 4	D. D. 5	D 6	D 7	D 8	D 9	D 10				
PMIC N/A PREPARED BY Joseph A. Kerby  STANDARD CHECKED BY			DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 http://www.landandmaritime.dla.mil														
MICRO DRA  THIS DRAWIN FOR US DEPAR AND AGEN DEPARTMEN		Charles ED BY Michae  APPRO	l A. Fry	e		MICROCIRCUIT, LINEAR, 8-BIT QUAD DIGITAL-TO-ANALOG CONVERTER, MONOLITHIC SILICON											
AM	SC N/A	REVISION		D				ZE 4		5962-87802 5962-87802							
								SH	EET		1 0	F 10					

# 1. SCOPE

- 1.1 <u>Scope</u>. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.
  - 1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 <u>Device type</u>. The device type identifies the circuit function as follows:

Device type	Generic number	Circuit function
01	7226	Four 8-bit digital-to-analog converters with output amplifiers

1.2.2 Case outlines. The case outlines are as designated in MIL-STD-1835 as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
R	GDIP1-T20 or CDIP2-T20	20	Dual-in-line
2	CQCC1-N20	20	Square leadless chip carrier

- 1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.
- 1.3 Absolute maximum ratings. 1/

AGND to DGND	dc to $V_{DD}$ $V_{DD}$ to +150°C W <u>3</u> /
Cases R and 2 See MII  Junction temperature (T <sub>J</sub> ) +150°C	

1.4 Recommended operating conditions.

Power supply range (V <sub>DD</sub> )	+11.4 V dc to +16.5 V dc
Input reference voltages:	
Dual supply operation	+2.0 V dc to V <sub>DD</sub> -4 V dc
Single supply operation	+10.0 V dc
Ambient operating temperature range (T <sub>A</sub> )	-55°C to +125°C

- / Unless otherwise specified all voltages are referenced to ground.
- Outputs may be shorted to AGND provided that the power dissipation of the package is not exceeded. Typically short circuit current to AGND is 60 mA.
- 3/ For temperatures above +75°C derate linearly at 2.0 mW/°C.

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### 2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

### DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

### **DEPARTMENT OF DEFENSE STANDARDS**

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

### DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at https://assist.daps.dla.mil/quicksearch/ or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

### 3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.
  - 3.2.1 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2 herein.
  - 3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.
  - 3.2.3 Truth table. The truth table shall be as specified on figure 2.
  - 3.2.4 Functional block diagram. The functional block diagram shall be as specified on figure 3.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full ambient operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

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TABLE I. Electrical performance characteristics (dual supply).

Test	Symbol	Conditions $\underline{1}/$ -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C	Group A subgroups	Device type	Lir	mits	Unit
		unless otherwise specified			Min	Max	
Supply current from V <sub>DD</sub>	I <sub>DD</sub>	Outputs unloaded, $V_{IN} = V_{INL}$ or $V_{INH}$	1, 2, 3	All		13.0	mA
Supply current from V <sub>SS</sub>	I <sub>SS</sub>	Outputs unloaded, $V_{IN} = V_{INL}$ or $V_{INH}$	1, 2, 3	All		11.0	mA
Reference voltage	$V_{REF}$		1, 2, 3	All	2.0	V <sub>DD</sub> - 4	V
Reference input resistance	Rı		1, 2, 3	All	2		kΩ
Reference input capacitance	C <sub>IN</sub>	Each DAC loaded with all 1's see 4.3.1c	4	All		300	pF
Total unadjusted error		V <sub>DD</sub> = +15 V ±5%, V <sub>REF</sub> = +10 V	1, 2, 3	All		±2	LSB
Relative accuracy			1, 2, 3	All		±1	LSB
Differential nonlinearity		Guaranteed monotonic	1, 2, 3	All		±1	LSB
Full scale error			1, 2, 3	All		±1.5	LSB
Zero code error			1, 2, 3	All		±30	mV
Input high voltage	V <sub>INH</sub>		1, 2, 3	All	2.4		V
Input low voltage	V <sub>INL</sub>		1, 2, 3	All		0.8	V
Input leakage current	I <sub>lkg</sub>	$V_{IN} = 0 \text{ V or } V_{DD}$	1, 2, 3	All		±1	μΑ
Functional tests		See 4.3.1d	7	All			
Voltage output slew rate 2/	SR		4, 5, 6	All	2.5		V/μs
Voltage output settling time (pos. full scale change) 2/	t <sub>tot</sub>	Settling time to $\pm 1/2$ LSB $V_{REF} = +10 \text{ V}$	4, 5, 6	All		5.0	μS
Voltage output settling time (neg. full scale change) 2/	t <sub>tot</sub>	Settling time to $\pm 1/2$ LSB $V_{REF} = +10 \text{ V}$	4, 5, 6	All		7.0	μS
Load resistance	Ro	V <sub>OUT</sub> = +10 V	4	All	2.0		kΩ
Address to write setup time	t <sub>AS</sub>		9, 10,11	All	0.0		ns
Address to write hold time	t <sub>AH</sub>		9, 10,11	All	10.0		ns
Data valid to write setup	t <sub>DS</sub>		9	All	90		ns
time			10,11		100		
Data valid to write hold time	t <sub>DH</sub>		9, 10, 11	All	10.0		ns
Write pulse width	t <sub>WR</sub>		9	All	150		ns
			10, 11	1	250		

See footnotes at end of table.

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TABLE I. <u>Electrical performance characteristics (single supply)</u> - continued.

Test	Symbol	Conditions $\underline{3}$ / -55°C $\leq$ T <sub>A</sub> $\leq$ +125°C	Group A subgroups	Device type	Lir	nits	Unit
		unless otherwise specified			Min	Max	
Supply current from V <sub>DD</sub>	I <sub>DD</sub>	Outputs unloaded, $V_{IN} = V_{INL}$ or $V_{INH}$	1, 2, 3	All		13.0	mA
Reference input resistance	Rı		1, 2, 3	All	2		kΩ
Reference input capacitance	C <sub>IN</sub>	Each DAC loaded with all 1's see 4.3.1c	4	All		300	pF
Total unadjusted error			1, 2, 3	All		±2	LSB
Differential nonlinearity		Guaranteed monotonic	1, 2, 3	All		±1	LSB
Input high voltage	V <sub>INH</sub>		1, 2, 3	All	2.4		V
Input low voltage	V <sub>INL</sub>		1, 2, 3	All		0.8	V
Input leakage current	I <sub>lkg</sub>	$V_{IN} = 0 \text{ V or } V_{DD}$	1, 2, 3	All		±1	μА
Functional tests		See 4.3.1d	7	All			
Voltage output slew rate 2/	SR		4, 5, 6	All	2.0		V/µs
Voltage output settling time (pos. full scale change) 2/	t <sub>tot</sub>	Settling time to $\pm 1/2$ LSB $V_{REF} = +10 \text{ V}$	4, 5, 6	All		5.0	μS
Voltage output settling time (neg. full scale change) 2/	t <sub>tot</sub>	Settling time to $\pm 1/2$ LSB $V_{REF} = +10 \text{ V}$	4, 5, 6	All		20.0	μS
Load resistance	Ro	V <sub>OUT</sub> = +10 V	4	All	2.0		kΩ
Address to write setup time	t <sub>AS</sub>		9, 10,11	All	0.0		ns
Address to write hold time	t <sub>AH</sub>		9, 10,11	All	10.0		ns
Data valid to write setup	t <sub>DS</sub>		9	All	90		ns
time			10,11		100		1
Data valid to write hold time	t <sub>DH</sub>		9, 10, 11	All	10.0		ns
Write pulse width	t <sub>WR</sub>		9	All	150		ns
			10, 11		250		1

 $<sup>1/</sup>V_{DD} = 11.4 \text{ V}$  to 16.5 V;  $V_{SS} = -5 \text{ V} \pm 10\%$ ; AGND = DGND = 0.0 V;  $V_{REF} = 2 \text{ V}$  to  $(V_{DD} - 4 \text{ V})$  (unless otherwise specified).  $1/V_{DD} = 11.4 \text{ V}$  to 16.5 V;  $1/V_{SS} = -5 \text{ V} \pm 10\%$ ; AGND = DGND = 0.0 V;  $1/V_{REF} = 10 \text{ V}$  (unless otherwise specified).

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Б	2.1
Device type	01
Case outline	R and 2
Terminal number	Terminal symbol
1	V <sub>OUT</sub> B
2	V <sub>OUT</sub> A
3	$V_{SS}$
4	$V_{REF}$
5	AGND
6	DGND
7	DB7 (MSB)
8	DB6
9	DB5
10	DB4
11	DB3
12	DB2
13	DB1
14	DB0 (LSB)
15	WR
16	A1
17	A0
18	$V_{DD}$
19	V <sub>OUT</sub> D
20	V <sub>OUT</sub> C

FIGURE 1. <u>Terminal connections</u>.

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Control inputs		ts	Operation	
WR	A1	A0	Operation	
Н	Х	Х	No operation device not selected	
L	L	L	DAC A transparent	
<u> </u>	L	L	DAC A latched	
L	L	Н	DAC B transparent	
<u> </u>	L	Н	DAC B latched	
L	Н	L	DAC C transparent	
<b>_</b>	Н	L	DAC C latched	
L	Н	Н	DAC D transparent	
<u> </u>	Н	Н	DAC D latched	

L = Low state, H = High state, X = Don't care

FIGURE 2. Truth table.

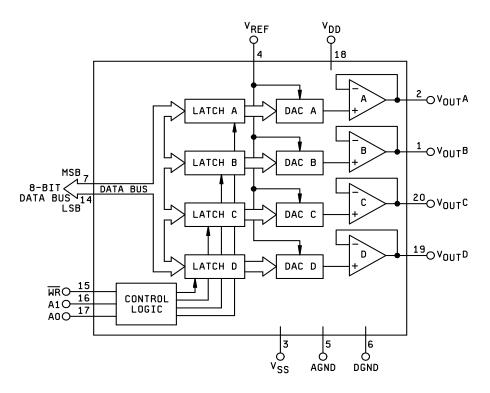


FIGURE 3. Functional block diagram.

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- 3.5 <u>Marking</u>. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.
- 3.5.1 <u>Certification/compliance mark</u>. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.
- 3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DLA Land and Maritime -VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change</u>. Notification of change to DLA Land and Maritime -VA shall be required for any change that affects this drawing.
- 3.9 <u>Verification and review</u>. DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

### 4. VERIFICATION

- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
  - a. Burn-in test, method 1015 of MIL-STD-883.
    - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
    - (2)  $T_A = +125^{\circ}C$ , minimum.
  - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	1
Final electrical test parameters (method 5004)	1*, 2, 3, 9
Group A test requirements (method 5005)	1, 2, 3, 4, 5, 6, 7, 9, (10, 11)**
Groups C and D end-point electrical parameters (method 5005)	1

<sup>\*</sup> PDA applies to subgroup 1.

4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

## 4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroup 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C<sub>IN</sub> measurement) shall be measured only for the initial test and after process or design changes which may affect input capacitance.
- d. Subgroup 7 tests shall verify the truth table on figure 2.

# 4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
  - (2)  $T_A = +125^{\circ}C$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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<sup>\*\*</sup> Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.
- 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.
- 6.4 <u>Record of users</u>. Military and industrial users shall inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DLA Land and Maritime -VA, telephone (614) 692-0544.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DLA Land and Maritime -VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0540.
- 6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime -VA.

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## STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 11-11-07

Approved sources of supply for SMD 5962-87802 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime -VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <a href="http://www.landandmaritime.dla.mil/Programs/Smcr/">http://www.landandmaritime.dla.mil/Programs/Smcr/</a>.

Standard microcircuit drawing	Vendor CAGE	Vendor similar
PIN <u>1</u> /	number	PIN <u>2</u> /
5962-87802012A	24355	AD7226TE/883B
	01295	TLC7226MFKB
5962-87802012C	01295	TLC7226MFKB
	1ES66	MX7226TE/883B
	<u>3</u> /	PM7226ARC/883
5962-8780201RA	24355	AD7226TQ/883B
	1ES66	MX7226TQ/883B
	<u>3</u> /	PM7226AR/883

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ <u>Caution</u>. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 3/ Not available from an approved source of supply.

Vendor CAGE number	Vendor name and address	
24355	Analog Devices Rt 1 Industrial Park PO Box 9106 Norwood, MA 0206 Point of contact:	
1ES66	Maxim Integrated F 120 San Gabriel Dr Sunnyvale, CA 940	
01295	Texas Instruments, Semiconductor Gro 8505 Forest Ln. PO Box 660199 Dallas, TX 75243 Point of contact:	

Sherman, TX 75090-9493

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